Product End-of-Life Disassembly Instructions

Product Category: Handheld Devices
Marketing Name / Model [List multiple models if applicable.]
HP Touchpad
Name / Model #2
Name / Model #3
Name / Model #4
Name / Model #5

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.
1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm	1
Batteries	All types including standard alkaline and lithium coin or button style batteries	1
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	1
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB/PCT)		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height		0
External electrical cables and cords		0
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above)		0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations.	0
Components and waste containing asbestos		0
Components, parts and materials containing refractory ceramic fibers		0

PSG instructions for this template are available at EL-MF877-01

Components, parts and materials containing radioactive substances		0

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Description #1 Screw driver "+"	Cross head of screwdriver
Description #2 Torque hard driver "*"	
Description #3 Screw driver "-"	
Description #4 Flat stick	
Description #5 Tweezers	

3.0 Product Disassembly Process

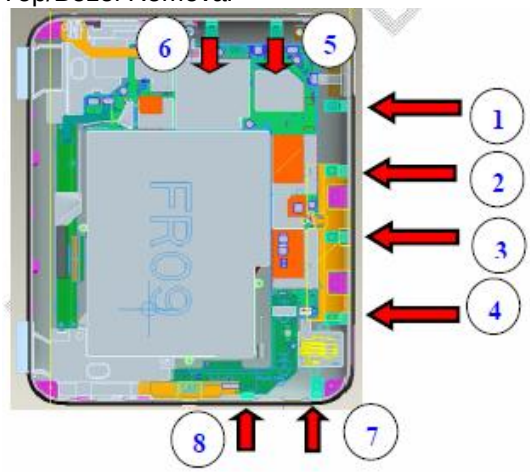
3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Remove Bezel - Follow the indicated directions (hooks' locations) and unlatch FPC
2. Unfasten screws to remove LCD from Bezel
3. Use hand to unfasten FPC's from pcba's, buttons, latches, camera module
4. Use screw driver to remove all PCBA's
5. Use tweezers to remove small components
6. Use screw drive to separate bottom assembly
7. Remove PCBA/Battery assembly
8. Separate PCBA from Battery
9. Use screw driver to separate PCBA module from base assembly
10. Remove speaker mesh and all other miscellaneous components
11. Disassembly complete
12.

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

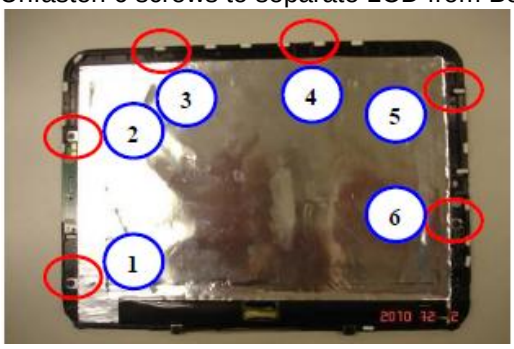
Tools

Top/Bezel Removal



Follow the indicated directions (hooks' locations) and genteelly use the **disassembly flat plastic stick** to unhook the hooks between BEZEL ASM and LCD ASM.
Unhook order: 1,2,3,4,5,6,7,8

Unfasten 6 screws to separate LCD from Bezel



Separated Bezel / LCD

PSG instructions for this template are available at EL-MF877-01

Separate bottom assembly

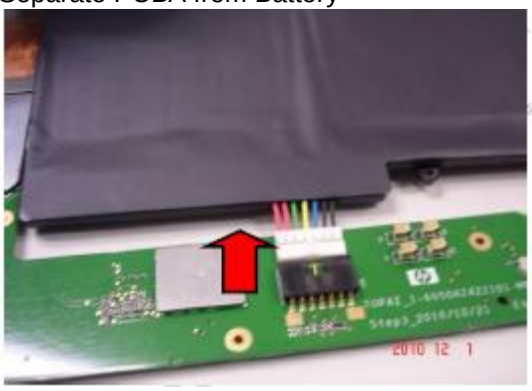
Use screwdriver (PH0 X 50) to unfasten the 9 indicated screws (6052B0053201).

Unfasten order: 1,2,3,4,5,6,7,8,9

Remove PCBA/Battery assembly

Disconnect the indicated speaker connector and take out the battery combined Main board from PCBA Frame Module (6070B0496701).

Separate PCBA from Battery

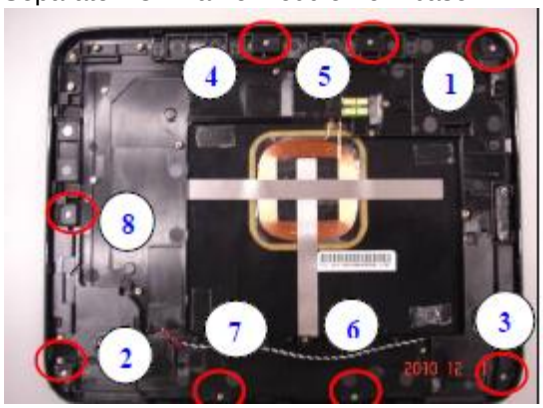


Follow the indicated direction to gently disconnect the Battery pack connector to separate Battery pack (6027B0091401) and Main board.

Caution:
Avoid damaging the Battery pack connector and wires

PSG instructions for this template are available at EL-MF877-01

Separate PCB frame module from base



Use screwdriver (PH0 X 50) to unfasten th
8 indicated screws (6052B0053201) to
separate PCBA Frame Module
(6070B0496701) and Base ASM

Unfasten order: 1,2,3,4,5,6,7,8

Remove speaker mesh and all other miscellaneous components

Tear off the indicated 2 Speaker meshes
(6054B0953601) from PCBA Frame
Module (6070B0496701).

Disassembly complete.

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